



Parameter	Rating	Units
Blocking Voltage	100	V _P
Load Current	100	mA _{rms} / mA _{DC}
On-Resistance (max)	16	Ω

Features

- 1500V_{rms} Input/Output Isolation
- 100% Solid State
- Low Drive Power Requirements (TTL/CMOS Compatible)
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- Tape & Reel Version Available

Applications

- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Security Systems
- Aerospace
- Industrial Controls
- Reed Relay Replacement

Description

CPC1016N is a miniature, low-voltage, low on-resistance, normally open (1-Form-A) solid state relay in a 4-lead SOP package. The relay uses optically coupled MOSFET technology to provide 1500V_{rms} of input/output isolation. The efficient MOSFET switches and photovoltaic die use IXYS Integrated Circuits Division's patented OptoMOS architecture while the optically coupled output is controlled by a highly efficient GaAIAs infrared LED.

The CPC1016N uses IXYS Integrated Circuits Division's state of the art double-molded vertical construction packaging to produce a very compact solid state relay that is ideal for replacing larger, less-reliable reed and electromechanical relays.

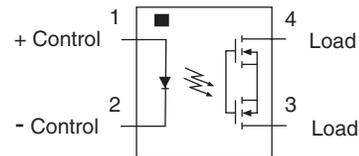
Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component:
TUV Certificate B 09 07 49410 004

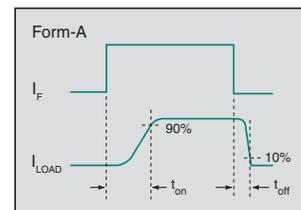
Ordering Information

Part #	Description
CPC1016N	4-Lead SOP (100/tube)
CPC1016NTR	4-Lead SOP (2000/reel)

Pin Configuration



Switching Characteristics of Normally Open Devices



Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	100	V _p
Reverse Input Voltage	5	V
Input Control Current Peak (10ms)	50	mA
	1	A
Input Power Dissipation	70	mW
Total Power Dissipation ¹	400	mW
Isolation Voltage, Input to Output	1500	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate linearly 3.33 mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

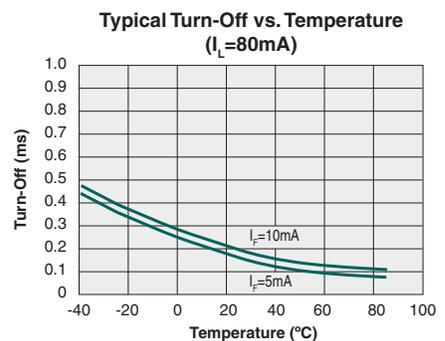
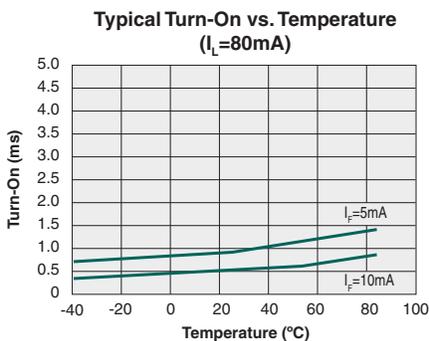
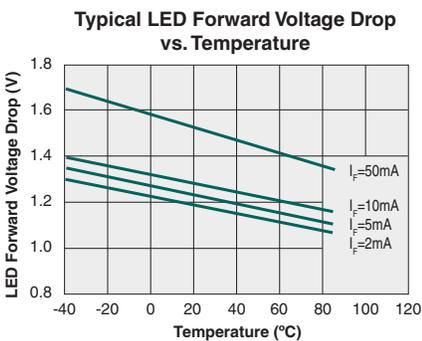
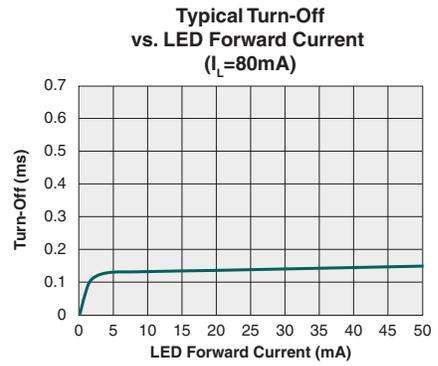
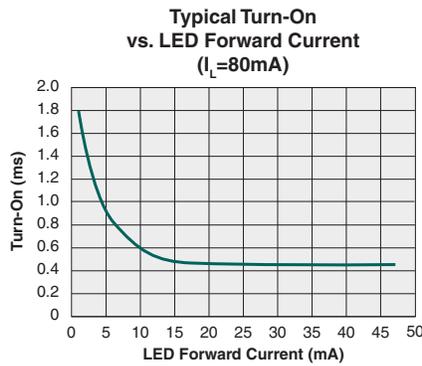
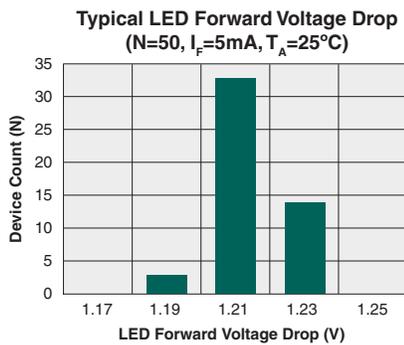
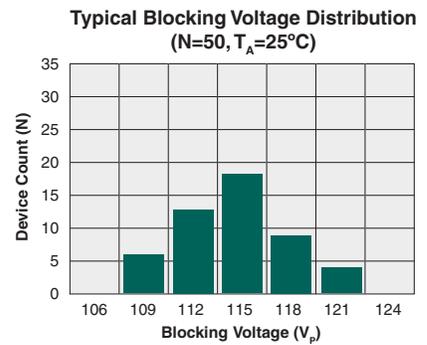
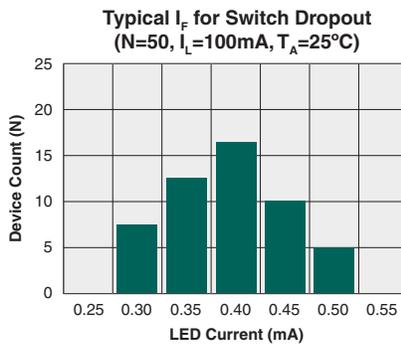
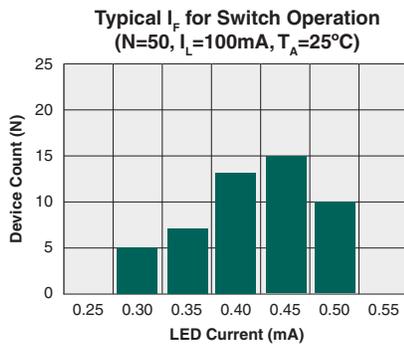
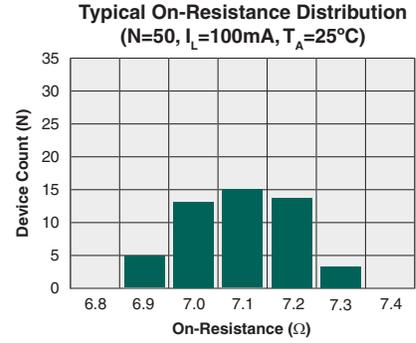
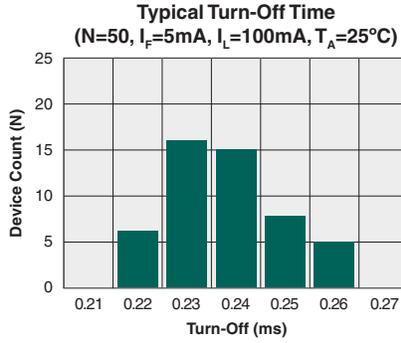
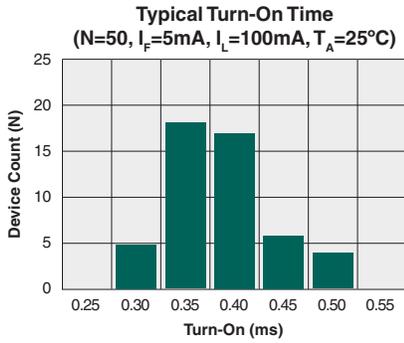
Electrical Characteristics @ 25°C

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current	-	I _L	-	-	100	mA _{rms} / mA _{DC}
Peak	t=10ms	I _{LPK}	-	-	±350	mA _p
On-Resistance ²	I _L =100mA	R _{ON}	-	-	16	Ω
Off-State Leakage Current	V _L =100V _p	I _{LEAK}	-	-	1	μA
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	t _{on}	-	-	2	ms
Turn-Off		t _{off}	-	-	0.5	ms
Output Capacitance	V _L =50V, f=1MHz	C _{OUT}	-	25	-	pF
Input Characteristics						
Input Control Current to Activate	I _L =100mA	I _F	-	0.5	2	mA
Input Control Current to Deactivate	-	I _F	0.3	0.4	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics						
Capacitance, Input to Output	-	C _{I/O}	-	1	-	pF

¹ Load current derates linearly from 100mA @ 25°C to 80mA @ 85°C.

² Measurement taken within 1 second of on-time.

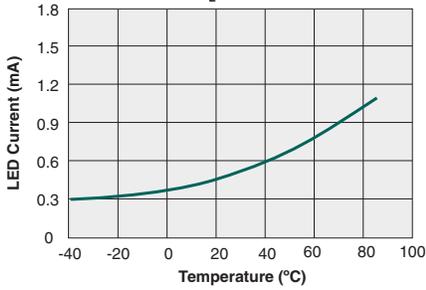
PERFORMANCE DATA *



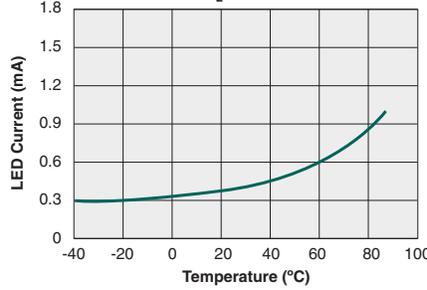
*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA *

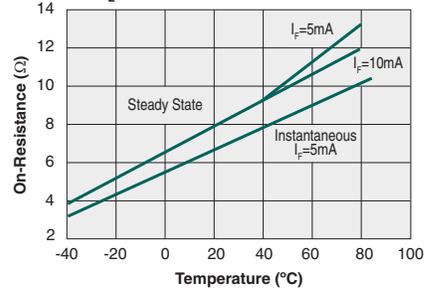
Typical I_F for Switch Operation vs. Temperature ($I_L=80mA$)



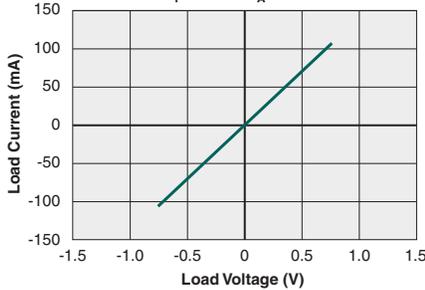
Typical I_F for Switch Dropout vs. Temperature ($I_L=80mA$)



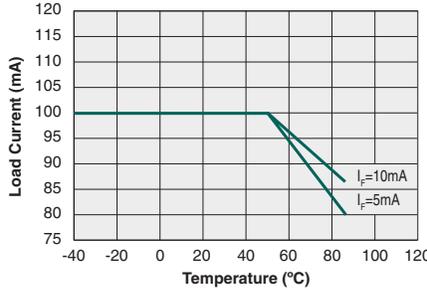
Typical On-Resistance vs. Temperature ($I_L=Max\ Rated\ @\ Temperature$)



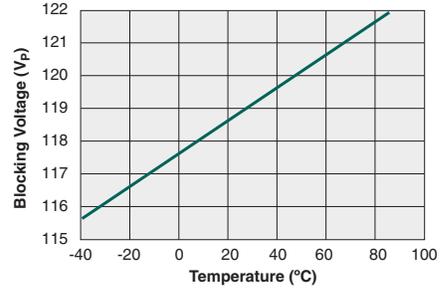
Typical Load Current vs. Load Voltage ($I_F=5mA, T_A=25°C$)



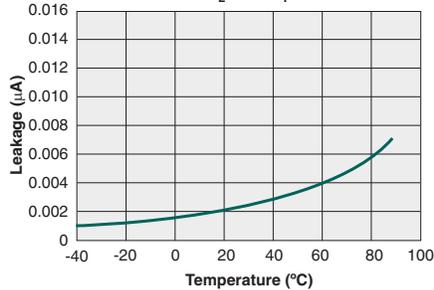
Typical Maximum Load Current vs. Temperature



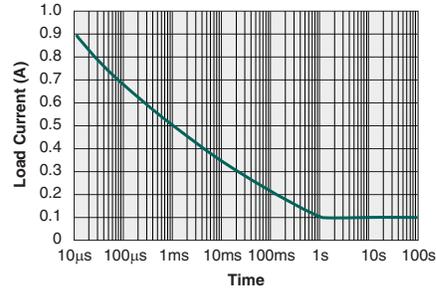
Typical Blocking Voltage vs. Temperature



Typical Leakage vs. Temperature Measured Across Pins 3&4 ($V_L=100V_P$)



Energy Rating Curve



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1016N	MSL 3

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
CPC1016N	260°C for 30 seconds

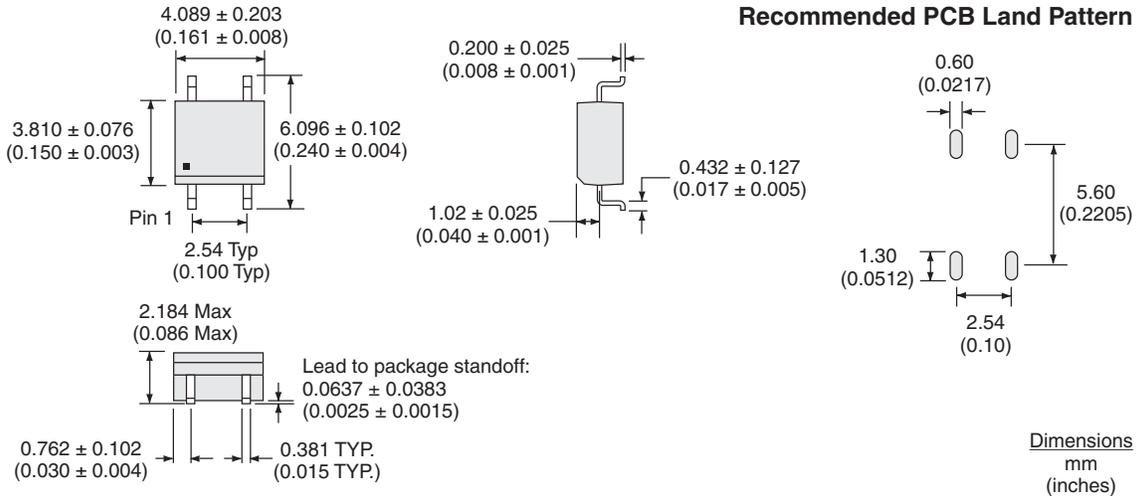
Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

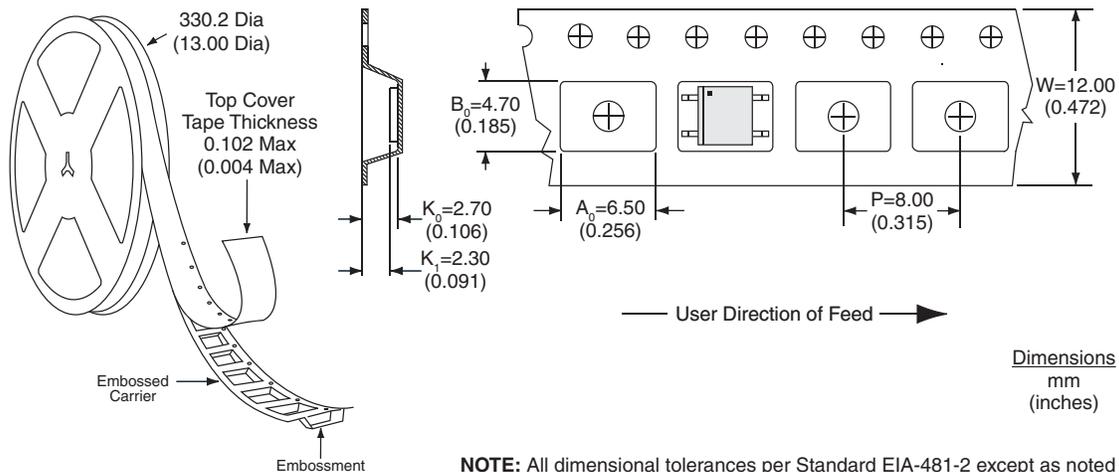


MECHANICAL DIMENSIONS

CPC1016N



CPC1016NTR Tape & Reel



For additional information please visit our website at: www.ixysic.com

IXYS Integrated Circuits Division makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in IXYS Integrated Circuits Division's Standard Terms and Conditions of Sale, IXYS Integrated Circuits Division assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of IXYS Integrated Circuits Division's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. IXYS Integrated Circuits Division reserves the right to discontinue or make changes to its products at any time without notice.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [Solid State Relays - PCB Mount](#) category:

Click to view products by [IXYS](#) manufacturer:

Other Similar products are found below :

[M86F-2W](#) [M90F-2Y](#) [G2-1A07-ST](#) [G2-1A07-TT](#) [G2-1B02-TT](#) [G2-DA06-ST](#) [923812OCAS](#) [PLA134S](#) [DS11-1005](#) [AQH3213J](#) [AQV212J](#)
[AQY412EHAJ](#) [EFR1200480A150](#) [901-7](#) [LCA220](#) [LCB110S](#) [1618400-5](#) [SR75-1ST](#) [AQH2213AJ](#) [AQV112KLJ](#) [AQV212AJ](#) [AQV212SXJ](#)
[AQV238AD01](#) [AQW414TS](#) [AQY221N2SYD01](#) [AQY221R2VJ](#) [AQY275AXJ](#) [AQY414SXE01](#) [G2-1A02-ST](#) [G2-1A03-ST](#) [G2-1A03-TT](#)
[G2-1A05-ST](#) [G2-1A06-TT](#) [G2-1A23-TT](#) [G2-1B01-ST](#) [G2-1B01-TT](#) [G2-1B02-ST](#) [G2-DA03-ST](#) [G2-DA03-TT](#) [G2-DA06-TT](#) [CPC1333GR](#)
[3-1617776-2](#) [CTA2425](#) [TLP3131\(F\)](#) [LBA110S](#) [LBB110S](#) [LCA110LSTR](#) [LCB126S](#) [WPPM-0626D](#) [WPPM-3526D](#)